# **Curriculum Vitae**

## Prof. Dr.-Ing. Hermann EUL

\* 1959 – Neustadt/Wied, Germany



## **Education:**

1981-1984	University of Applied Science Koblenz, Germany: Bachelor of Science,
	Engineering, Communication Technology
1984-1987	University of Bochum, Germany: Master of Science, Electrical Engineering, RF-
	Technology, Signal Processing, Communication Technology
1987-1990	University of Bochum, Germany: PhD, Engineering Science, RF-Technology
2003	Leibniz-University Hanover, Germany: University Professor (C4) Chair for RF-
	Technology and Radio Systems

#### **Profession:**

1991–1999	SIEMENS NETWORKS, SIEMENS SEMICONDUCTORS
1991–1996	Project Manager Siemens Information & Communication Networks
1996–1997	Executive Director & General Manager Video & Audio ICs Business Unit
1997–1999	Executive Director & General Manager Telecom & Datacom ICs Business Unit
1999–2002	INFINEON TECHNOLOGIES
1999–2001	Vice President & General Manager Wireless Baseband & Systems Business Unit
2001–2002	Senior Vice President & General Manager Security & Chip Card ICs Business Group
2003–2004	UNIVERSITY OF HANOVER
2003-2004	
	Professor and Head of Chair High Frequency Technology and Radio Systems
2004–2011	INFINEON TECHNOLOGIES
<b>2004–2011</b> 2004–2004	INFINEON TECHNOLOGIES Senior Vice President & General Manager, Wireline Communication Business Unit
	Senior Vice President & General Manager, Wireline Communication
2004–2004 2005–2005 2005–2008	Senior Vice President & General Manager, Wireline Communication Business Unit Group Vice President & General Manager, Communications Group President Communication Group & Member Executive Board
2004–2004 2005–2005	Senior Vice President & General Manager, Wireline Communication Business Unit Group Vice President & General Manager, Communications Group
2004–2004 2005–2005 2005–2008 2008–2011	Senior Vice President & General Manager, Wireline Communication Business Unit Group Vice President & General Manager, Communications Group President Communication Group & Member Executive Board Executive Vice President Sales, Marketing, Technology & R&D, Member of the Management Board
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## **Mandates:**

2015-present	Knowles Corp., Itasca, IL, USA: Board of Directors
2015-present	Tactual Labs Co., New York, NY, USA: Board of Directors
2018-present	Cradle LLC, Mountain View, CA, USA: Board of Directors
2019-present	ARRI AG, Munich, Germany: Supervisory Board

#### **Further Functions:**

2017-present	Digital+ Partners, Frankfurt/Munich, Germany: Board of Advisors
2017-present	Bryan, Garnier & Co, Paris, London, Munich, New York:
	Executive Advisor
2017-present	Maja Systems Inc., Milpitas, CA, USA: Board of Advisors
2017-present	Coolstar Inc., Sunnyvale, CA, USA: Board of Advisors
2018-present	VDE, Verband der Elektrotechnik Elektronik Informationstechnik,
	Frankfurt, Germany: Supervisory Board
2018-present	LumiLeds Inc., San Jose, CA, USA: Board of Advisors
2018-present	Accenture GmbH & Co. KG Germany: Board of Advisors Industrial
	Equipment
2018-present	MINE GmbH, Berlin, Germany: Board of Advisors
2019-present	Silicon Austria Labs, Austria, Scientific Advisory Board